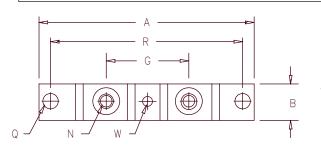
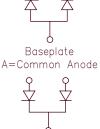
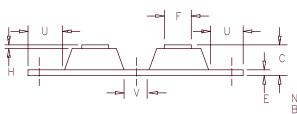
Schottky PowerMod







Basepiate				
Common Cathode				
6				
Baseplate				
D=Doubler				

Notes: Baseplate: Nickel plated copper

Dim. Ir	Dim. Inches		Millimeters	
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490 G 1.375	0.510 BSC	34.9	16.00 3.30 12.95	
H 0.010 N Q 0.275 R 3.15 U 0.600 V 0.312 W 0.180	0.290 0 BSC 0.340	6.99 80.0 15.24 7.92		1/4-20 Dia.

Microsemi Catalog Number		Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
CPT30035* CPT30040* CPT30045*	301CNQ035 301CNQ040 301CNQ045 MBRP30045CT	35V 40V 45V	35V 40V 45V
CPT30050*		50V	50V
*Add Suf	fix A for Comr	mon Anode, D for	Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 300 Amperes/35 to 50 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

F(AV) 300 Amps Average forward current per pkg Average forward current per leg F(AV) 150 Amps IFSM 2000 Amps Maximum surge current per leg Maximum repetitive reverse current per leg | R(OV) 2 Amps | Max peak forward voltage per leg | VFM | 0.70 Volts Max peak forward voltage per leg V_{FM} 0.76 Volts Max peak forward voltage per leg Max peak reverse current per leg ^IRM 75 mA Max peak reverse current per leg ^IRM 4.0 mA C_{J} Typical junction capacitance per leg 4600 pF

 T C = 136°C, Square wave, R OJC = 0.20°C/W T C = 136°C, Square wave, R OJC = 0.40°C/W 8.3ms, half sine, T J = 175°C f = 1 KHZ, 25°C FM = 200A:TJ = 125°C*

TFM = 200A:TJ = 25°C* VRRM,TJ = 125°C* VRRM,TJ = 25°C

 $V_{R} = 5.0V, T_{C} = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics TSTG Storage temp range -55℃ to 175℃ ΤJ -55°C to 175°C 0.40°C/W Junction to case Operating junction temp range R OJC Max thermal resistance per leg R OJC Max thermal resistance per pkg 0.20°C/W Junction to case Typical thermal resistance (greased) Recs 0.08°C/W Case to sink Terminal Torque 35-40 inch pounds Mounting Base Torque (outside holes) 30-40 inch pounds Mounting Base Torque (center hole) center hole must be torqued first 8-10 inch pounds 2.8 ounces (75 grams) typical Weight



CPT30035 — CPT30050

Figure 1 Typical Forward Characteristics — Per Leg

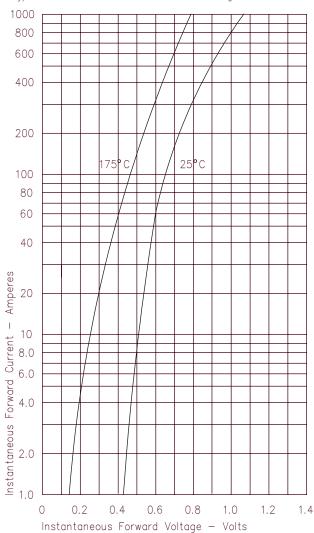


Figure 3 Typical Junction Capacitance — Per Leg 100,000 60,000 40,000 20,000 Junction Capacitance 10,000 6000 4000 2000 1000 0.1 0.5 1.0 5.0 10 50 100 Reverse Voltage - Volts

Figure 4

Forward Current Derating — Per Leg

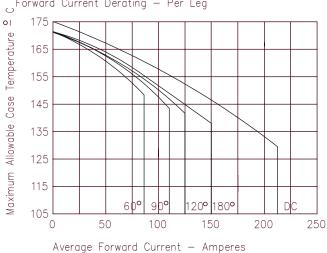


Figure 2 Typical Reverse Characteristics — Per Leg

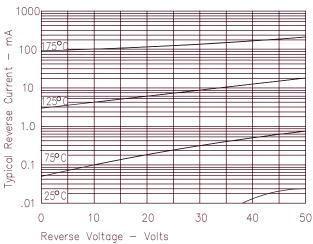
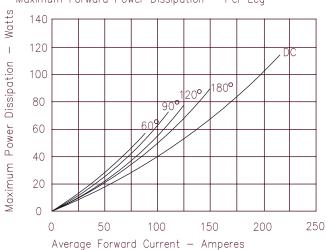


Figure 5
Maximum Forward Power Dissipation — Per Leg





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